NSN 5962-01-120-4853

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View Online at https://aerobasegroup.com/nsn/5962-01-120-4853 **Body Length:** 0.840 inches **Body Width:** 0.310 inches **Body Height:** 0.185 inches **Maximum Power Dissipation Rating:** 794.0 milliwatts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Schottky and bipolar and presettable and monolithic and thin film and w/active pull-up and 3-state output and high impedance and hermetically sealed and burn in and tested to mil-std-883 **Inclosure Material:** Ceramic **Inclosure Configuration:** Dual-in-line **Output Logic Form:** Transistor-transistor logic **Case Outline Source And Designator:** D-2 mil-m-38510 **Current Rating Per Characteristic:** 140.00 milliamperes reverse current, dc absolute **Terminal Surface Treatment:** Solder **Voltage Rating And Type Per Characteristic:** 7.0 volts power source **Time Rating Per Chacteristic:** 85.00 nanoseconds propagation delay time, high to low level output **Memory Device Type:** Prom **Test Data Document:** 96906-mil-std 883 standard (includes industry or association standards, individual manufactureer standards, etc.). **Terminal Type And Quantity:** 16 printed circuit Shelf Life: N/a **Unit Of Measure:**

Yes - demil/mli

Demilitarization:

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